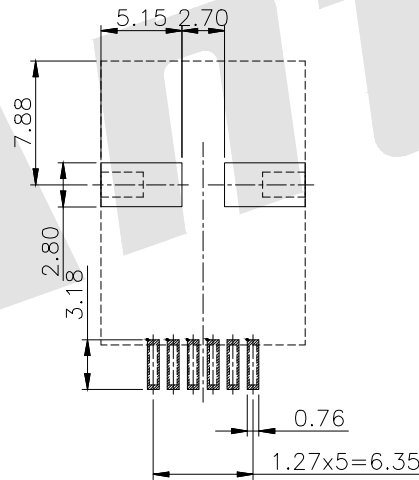
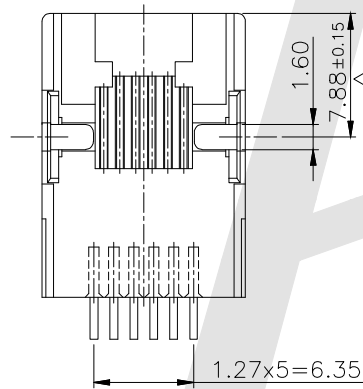
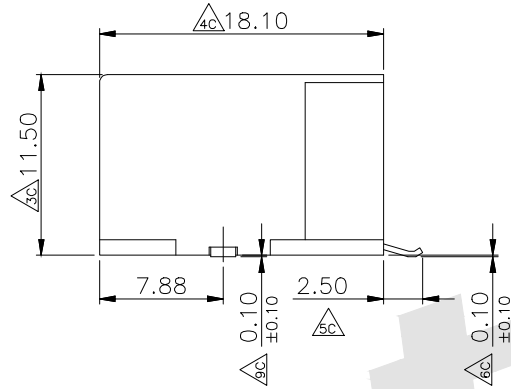
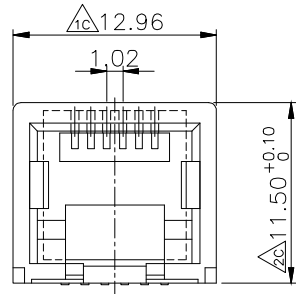


HSF



PCB LAYOUT TOP VIEW

Mechanical:

Operating:750 Cycles Min

Environmental:

- 1.Storage:-40° C To +85° C
- 2.Operation:-20° C To +75° C
- 3.IR Reflow Soldering Temperture:255° C To 265° C
- Mates With Modular Plug Conforming To FCC Part 68,Subpart F.

MATERIAL:

- 1.HOUSING MATERIAL :HIGH TEMP . THERMOPLASTIC
FLAMMABILITY RATING UL94V-0.
2. CONTACT :PHOSPHOR BRONZE
- 3.PLATING: GOLD PLATING OVER NICKEL IN CONTACT
TIN PLATING OVER NICKEL IN SOLDER AREA
- 4.SOLDER PADER:BRASS PLATING NICKEL ALLOY

ELECTRICAL CHARACTERISTICS:

- 1.CURRENT PATING :1.5 AMP
- 2.CONTACT RESISTANCE :40 MILLIOHMS MAX
- 3.INSULATION RESISTANCE:1000 MEGOHMS MIN @ 500V DC.
- 4.DIELECTRIC WITHSTANDING RESISTANCE: 1000VAC 1MIN
- 5.Voltage Rating:125Vac Rms

Order Code:

ATRJ5831 - 6P - 6C - X - A - X

① ② ③ ④ ⑤ ⑥

- ① SERIES NO:
- ② NUMBER OF POSITIONS(8P, 6P, 4P)
- ③ NUMBER OF CONTACTS (8C, 6C, 4C)
- ④ Contact Plating
G0:Gold flash
G1: 3U" Gold
G2: 5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
SN:Tin

- ⑤ Shield
A:W/O Shield

- ⑥ packing:
A: Tray packing
R: Tape & Reel

Unless Otherwise specified tolerance
X. ±0.35 X.XX: ±0.20
X.X: ±0.25 X.XXX: ±0.15

SCALE: As Shown	UNIT: mm
DRAW Wu Feng Rong	DATE 07/17/2021
CHECK BobYang	DATE 07/17/2021

Antenk® ANTENK ELECTRONICS CO.,LTD
Http://www.antenk.com
E-mail:sales@antenk.com

TITLE:
RJ11 SIDE ENTRY SMT JACK L IRON SHEET

DRAWING NO: ATRJ5832-6P6C-X-A-X

PRODUCT NO: ATRJ5832-6P6C-X-A-X



REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		